

MEC8-140-02-L-VP

MEC8-110-02-L-VP



MEC8-VP SERIES

(0,80 mm) .0315"

PRESS FIT MICRO EDGE CARD SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MEC8-VP

Insulator Material:

Liquid Crystal Polymer

Contact Material:

Copper

Plating:

Au or Sn over 50µ" (1,27 µm) Ni

Operating Temp Range:

-55°C to +125°C

Current Rating:

3.3 A per pin (1 pin powered per row)

Voltage Rating:

300 VAC/425 VDC

RoHS Compliant:

Yes

Processing:

Lead-Free Solderable:

Yes

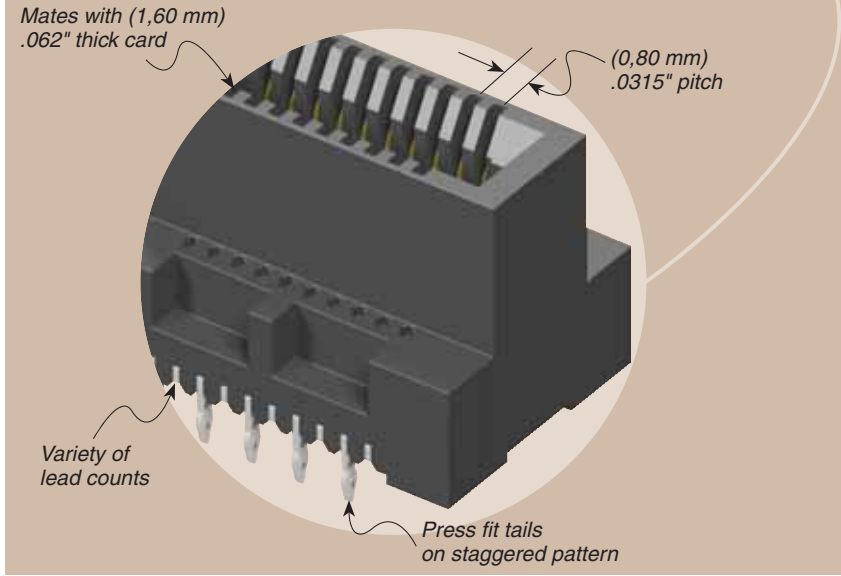
Mates with: (1,60 mm) .062" thick cards

Mates with (1,60 mm) .062" thick card

(0,80 mm) .0315" pitch

Variety of lead counts

Press fit tails on staggered pattern

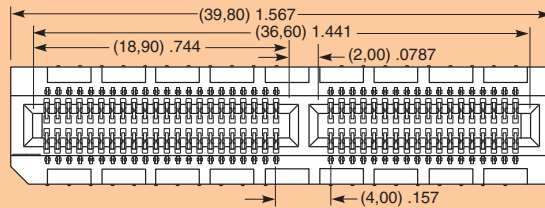


RECOGNITIONS

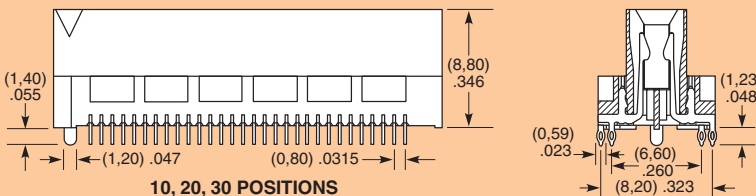
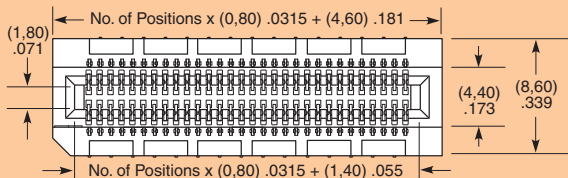
For complete scope of recognitions see www.samtec.com/quality



FILE NO. E111594



40 POSITIONS



10, 20, 30 POSITIONS

Note: Patent Pending

Note: While optimized for 50Ω applications, this connector with alternative signal/ground patterns may also perform well in certain 75Ω applications. Contact Samtec for further information.

Note: Some sizes, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM